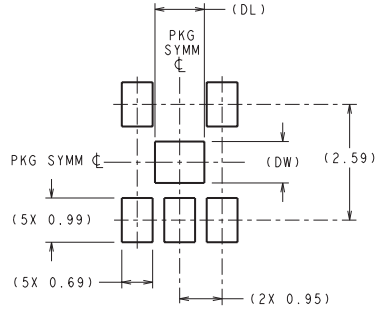
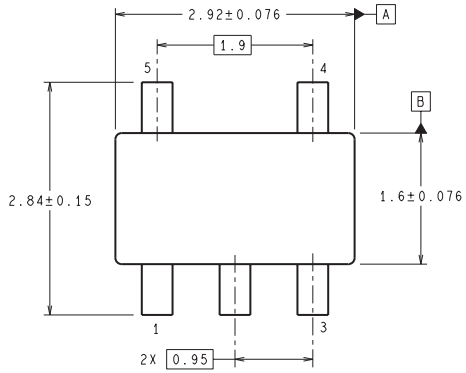
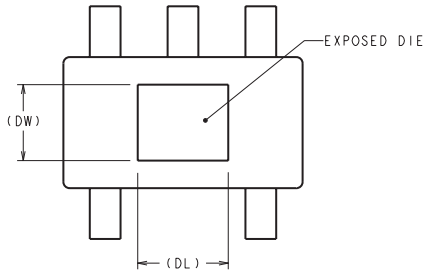
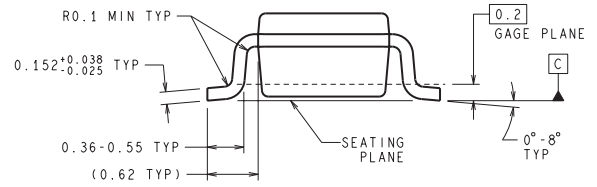
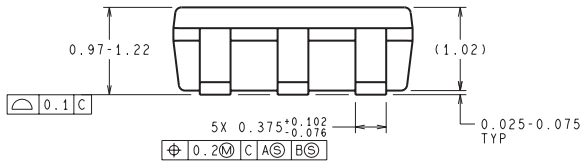


NEA0005AA



RECOMMENDED LAND PATTERN



DIE SIZE CODE IN DWG No. (XX)	DL	DW
AA	1.105	0.927

DIMENSIONS ARE IN MILLIMETERS
DIMENSIONS IN () FOR REFERENCE ONLY

MNA05XX (Rev B)

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